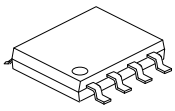
5.0A, 80V DUAL N-CHANNEL ENHANCEMENT MODE POWER MOSFET



SOP-8

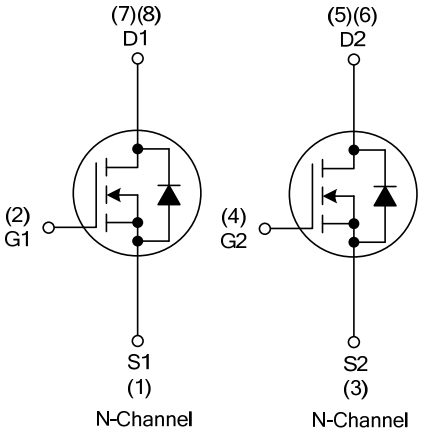
■ DESCRIPTION

The UTC **UT5NN08M** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with low Rdson characteristic by high cell density trench technology.

■ FEATURES

* $R_{DS(ON)}$ ≤ 85 mΩ @ V_{GS}=10V, I_D=2.5A
  $R_{DS(ON)}$ ≤ 110 mΩ @ V_{GS}=4.5V, I_D=2.5A
* Fast Switching Speed
* Simple Drive Requirement

■ SYMBOL



■ ORDERING INFORMATION

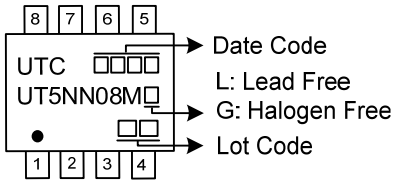
Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT5NN08ML-S08-R	UT5NN08MG-S08-R	SOP-8	S1	G1	S2	G2	D2	D2	D1	D1	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

UT5NN08MG-S08-R

(1)Packing Type	(1) R: Tape Reel
(2)Package Type	(2) S08: SOP-8
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING


8
7
6
5
UTC
UT5NN08M□
Date Code
L: Lead Free
G: Halogen Free
Lot Code
1
2
3
4

■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	80	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I_D	5	A
	Pulsed (Note 2)	I_{DM}	10	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	4	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.6	V/nS
Power Dissipation		P_D	1.6	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L = 1mH, I_{AS} = 2.8A, V_{DD} = 25V, R_G = 25Ω, Starting T_J = 25°C.
4. I_{SD} ≤ 5.0A, di/dt ≤ 200A/μs, V_{DD} ≤ $V_{(BR)DSS}$, T_J = 25°C.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	125	°C/W
Junction to Case	θ_{JC}	78	°C/W

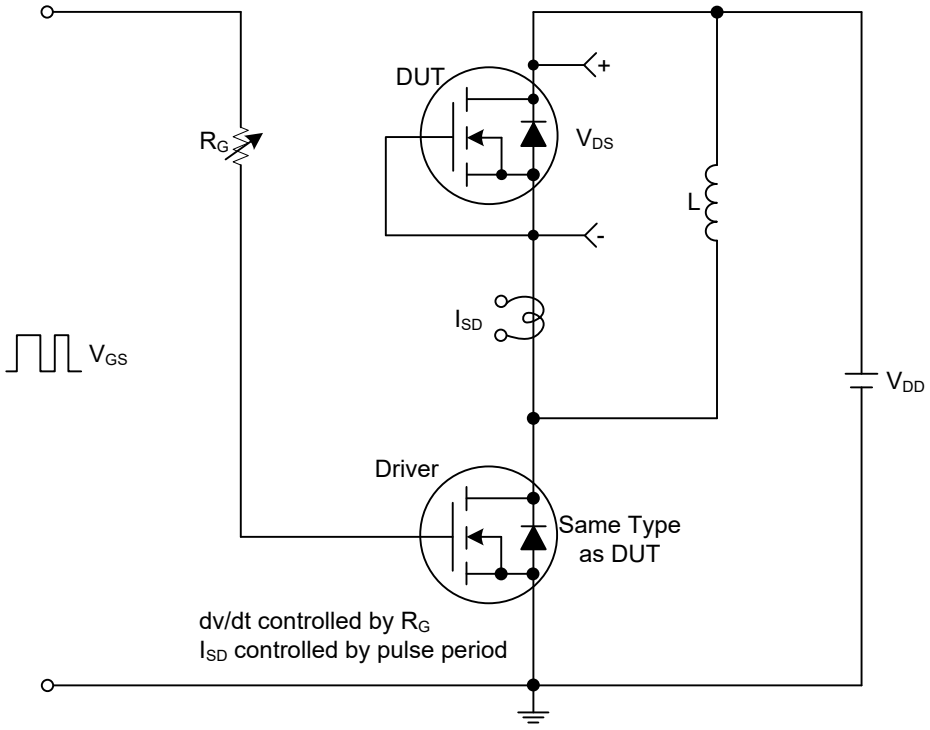
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

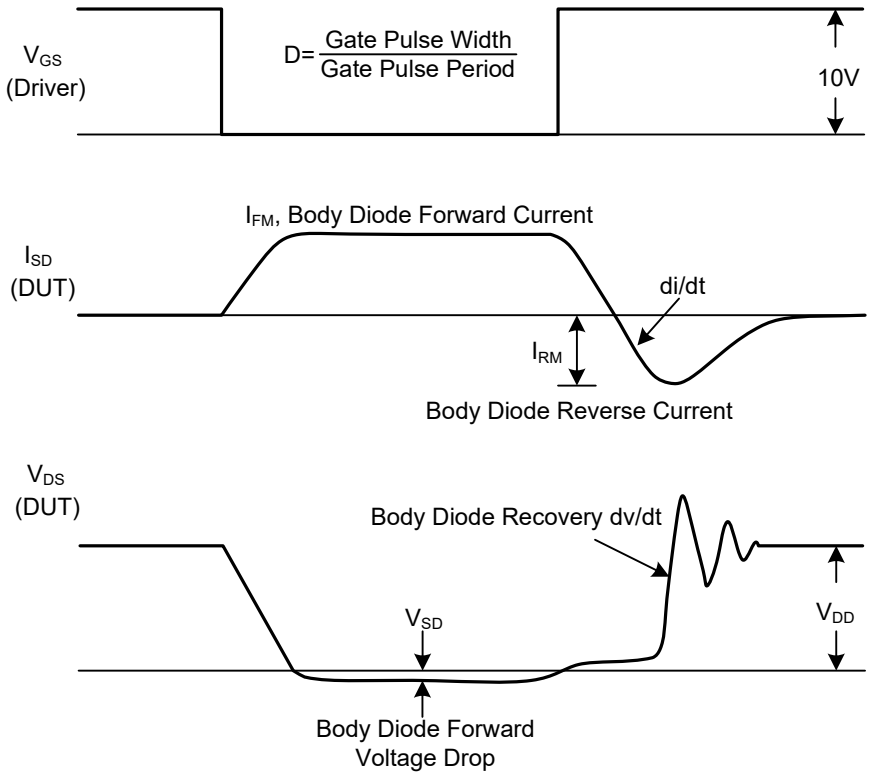
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V, I_D=250μA	80			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=80V, V_{GS}=0V			1	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=+20V, V_{DS}=0V			100	nA
	Reverse		V_{GS}=-20V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	1.0		3.0	V
Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=2.5A			85	mΩ
			V_{GS}=4.5V, I_D=2.5A			110	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{DS}=25V, V_{GS}=0V, f=1.0MHz		515		pF
Output Capacitance		C_{OSS}			40		pF
Reverse Transfer Capacitance		C_{RSS}			31		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=64V, V_{GS}=10V, I_D=5.0A (Note 1, 2)		20		nC
Gate-Source Charge		Q_{GS}			4		nC
Gate-Drain Charge		Q_{GD}			4		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V_{DD}=40V, V_{GS}=10V, I_D=5.0A, R_G=3Ω (Note 1, 2)		5		ns
Turn-ON Rise Time		t_R			17		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			15		ns
Turn-OFF Fall Time		t_F			18		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				5	A
Maximum Body-Diode Pulsed Current		I_{SM}				10	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S =5.0A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	I_S =5.0A, V_{GS}=0V, dI_F/dt=100A/μs		20		ns
Body Diode Reverse Recovery Charge		Q_{rr}			17		nC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



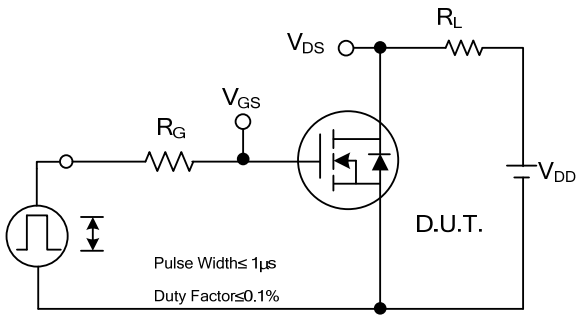
Peak Diode Recovery dv/dt Test Circuit



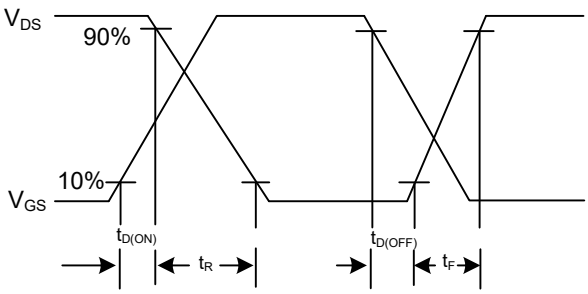
Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

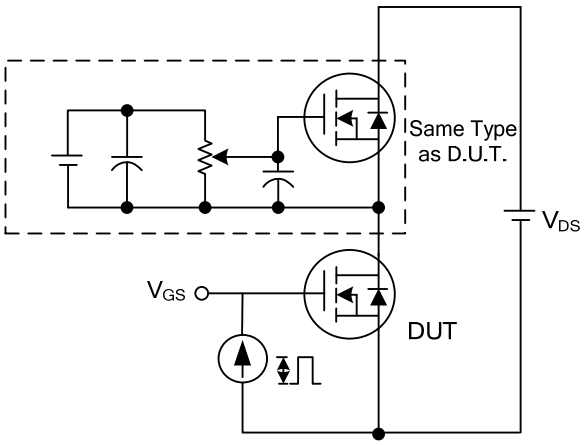
■ TEST CIRCUITS AND WAVEFORMS



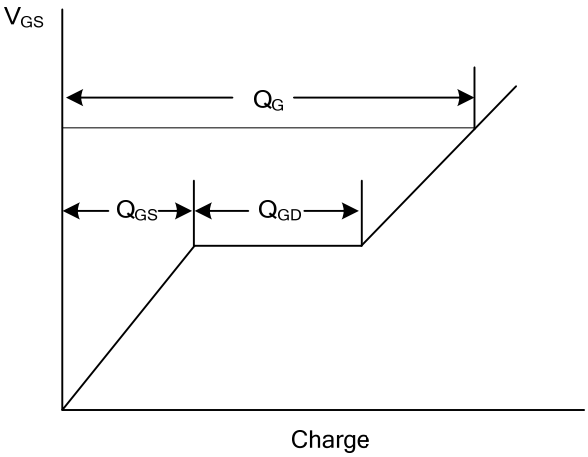
Switching Test Circuit



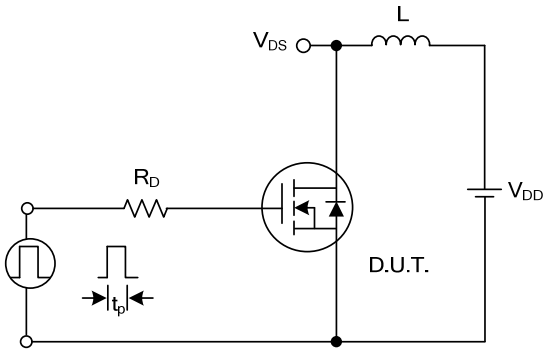
Switching Waveforms



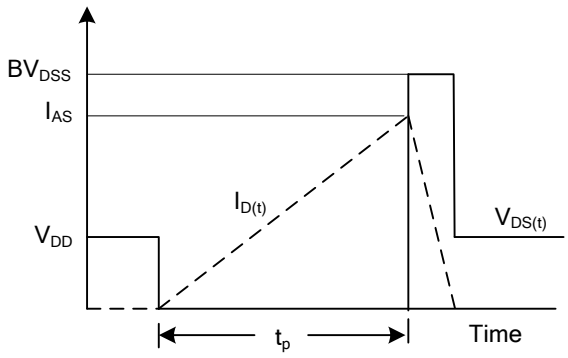
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms